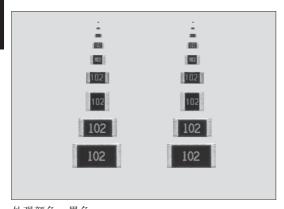
THICK FILM (GENERAL PURPOSE)



RK73BI矩形片式电阻器Flat Chip Resistors



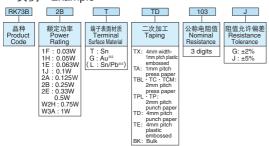
外观颜色: 黑色 Coating color: Black

■ 特点 Features

- 小型•轻量。
- ●由于电阻器的保护膜使用了金属釉厚膜,因此耐热性• 耐候性优异。
- ●电极为三层结构,具有稳定性和高信赖性。
- ●对应编带、散装箱方式等各种自动安装机。
- ●对应回流焊、波峰焊。
- ●端子无铅电镀品,符合欧盟RoHS。电极、电阻膜层、 玻璃中所含的铅玻璃不适用欧盟RoHS指令。
- AEC-Q200相关数据已取得(除1F)。
- Small size and light weight.
- Excellent heat resistance and weather resistance are ensured by the use of metal glaze thick film.
- High stability and high reliability with the triple-layer structure of electrode.
- Applicable to various kinds of automatic mounters for taping, etc.
- Suitable for both flow and reflow solderings.
- Products with lead free termination meet EU-RoHS requirements. EU-RoHS regulation is not intended for Pbglass contained in electrode, resistor element and glass.
- AEC-Q200 qualified (Exemption 1F).

■ 品名构成 Type Designation

实例 Example



※2 镀金电极,对应IE、IJ、2A(10Ω~1MΩ)由于规格不同,请与本公司商谈※3 IF、IH、W2H、W3A尺寸只对应端子表面材质T。

- X2 Products with gold plated electrodes are also available with 1E, 1J and 2A types $(10\Omega \sim 1M\Omega)$, so please consult with us.
- X3 With type 1F, 1H, W2H, W3A, only T is available as the terminal surface material.

端子表面材质,以无铅品为准。

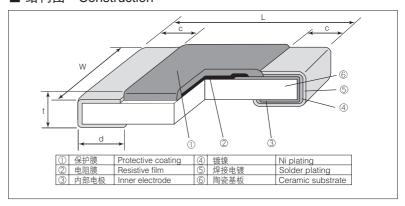
欲知关于此产品含有的环境负荷物质详情(除EU-RoHS以外), 请与我们联系。

编带细节参照卷末附录C。

The terminal surface material lead free is standard

For further information on taping, please refer to APPENDIX C on the

■ 结构图 Construction



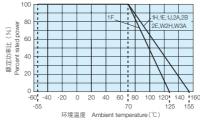
■ 外形尺寸 **Dimensions**

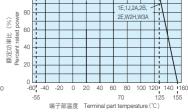
型号 Type	尺寸 Dimensions (mm)							
(Inch Size Code)	L	W	С	d	t	(1000pcs)		
1F (01005)	0.4±0.02	0.2±0.02	0.10±0.03	0.11±0.03	0.13±0.02	0.04		
1H (0201)	0.6±0.03	0.3±0.03	0.1±0.05	0.15±0.05	0.23±0.03	0.14		
1E (0402)	1.0 +0.1 -0.05	0.5±0.05	0.2±0.1	0.25 +0.05	0.35±0.05	0.68		
1J (0603)	1.6±0.2	0.8±0.1	0.3±0.1	0.3±0.1	0.45±0.1	2.14		
2A (0805)	2.0±0.2	1.25±0.1	0.4±0.2	0.3 +0.2 -0.1	0.5±0.1	4.54		
2B (1206)	3.2±0.2	1.6±0.2		0.4 +0.2		9.14		
2E (1210)	3.2±0.2	2.6±0.2	0.5±0.3	U.4 _{-0.1}	0.6±0.1	15.5		
W2H (2010)*1	5.0±0.2	2.5±0.2	0.5-0.3	0.65±0.15	0.0 ± 0.1	24.3		
W3A (2512)*1	6.3±0.2	3.1±0.2		0.65 ± 0.15		37.1		

※1 也对应RK73B 2H,RK73B 3A ("d"尺寸不同。"d"尺寸=0.4^{+0.2} mm)

X1 RK73B 2H and RK73B 3A are also still available (different "d" dimensions=0.4 ^{+0.2} mm)

■ 负荷减轻特性曲线 **Derating Curve**





轻特性曲线,减小额定功率。

For resistors operated at an ambient temperature of 70°C or above, a power rating shall be derated in accordance with the above derating curve.

在环境温度70℃以上使用时,应按照上图负荷减超过上述端子部温度使用时,请根据负荷减轻 特性曲线减小额定功率后使用。

> ※ 有关使用方法,请参照卷首的"端子部温 度负荷减轻特性曲线的说明"。

For resistors operated terminal part temperature of described for each size or above, a power rating shall be derated in accordance with dera-ting

*Please refer to "Introduction of the derating curves based on the terminal part temperature" on the beginning of our catalog before use.

■ 参考标准 Reference Standards

IEC 60115-8 JIS C 5201-8 EIAJ RC-2134C



■ 额定值 Ratings

型 号 Type	电阻温度 系数 T.C.R. (×10°/K)	额定功率 Power Rating	电阻值范围 Resistance Range (Ω)		Max.	最高 过载电压 Max.	额定 环境温度 Rated Ambient	额定 端子部温度 Rated Terminal	二次加工和包装数量/卷 Packaging & Q'ty/Reel(pcs)						
			G: ±2% E24	J:±5% E24	Working Voltage	Overload Voltage	Temp.	Part Temp.	TX	TBL	TA	тс - тсм	TPL · TP	TD	TE
	±200	0 03W	100k~1M	100k∼1M	20V	20V 30V		_	40,000	20,000	_	_	_	_	_
1F	±250		100∼91k	100∼91k											
''	±300		10~91	10~91											
	0~+300		1~9.1	1~9.1											
1H	±200	0.05W	10~10M	10~10M	25V 50V	50V			_	_	35,000	TC : 10,000	_	_	_
	±400	0.000111	_	1.0~9.1							TCM: 15,000	TDI 00.000		\vdash	
1E	±200	0.063W (0.1W ^{×4})	1.0~10M	1.0~10M	50V	100V	70°C	125°C	_	_		_	TPL: 20,000 TP: 10,000	_	-
1J	±200	0.1W	1.0~10M	1.0~10M						_			TP: 10,000	5,000	
10	±400	(0.125W ^{×4})	_	11M~22M									11 . 10,000	5,000	
2A	±200	0.125W	1.0~1M	1.0~1M	150\/	150V 200V			_	_	_	_	TP: 10,000	5,000	4,000
2/1	±400	(0.25W ^{×4})		1.1M~10M	100 V								11 . 10,000	0,000	4,000
2B	±200	0.25W	1.0~5.6M	1.0~5.6M		400V						_	_	5,000	4,000
	±400		6.2M~10M												
	2E ±200	0.5W	10∼1k	1.0∼1k	200V					1					
2E		0.33W	1.1k∼5.6M	1.1k∼5.6M					_		_	-	_	5,000	4,000
	±400	(0.5W ^{×4})	_	6.2M~10M						\perp				igsquare	\vdash
W2H	±200	0.75W	10~5.6M	1.0~5.6M					_	_	_	_	_	_	4,000
	±400		_	6.2M~22M											.,500
W3A	W3A ±200	1.0W	10~5.6M	1.0∼5.6M	200V	400V (500V ^{×4})			_	_	_	_	_	_	4,000
±40	±400		_	6.2M~22M	(500V ^{×4})										

使用温度范围 Operating Temperature Range: -55℃~+125℃ (1F) , -55℃~+155℃ (1H•1E•1J•2A•2B•2E•W2H•W3A)

额定电压是√额定功率×公称电阻值所算出的值或表中最高使用电压两者中小的值为额定电压。

Rated voltage = $\sqrt{\text{Power Rating} \times \text{Resistance value}}$ or Max. working voltage, whichever is lower.

跳线片式电阻器请参照RK73Z系列。

For flat chip jumper resistor, please refer to RK73Z series.

※4()内额定功率、最大工作电压和最大负荷电压请和我们商议。

**4 Please consult with us about the Power rating, the Max. working voltage and the Max. overload voltage with ().

■ 性能 Performance

试验项目 Test Items	标准值 Performance Requirements $\Delta R \pm (\% + 0.1 \Omega)$		试验方法 Test Methods			
rest items	保证值 Limit	代表值 Typical				
电阻值 Resistance	在规定的允许偏差内 Within specified tolerance	-	25℃			
电阻温度系数 T.C.R.	在规定值以内 Within specified T.C.R.	-	+25°C/-55°C and +25°C/+125°C			
过载(短时间)	2	1: 1F	额定电压×2.5倍施加5秒钟(2B:额定电压×2倍)			
Overload(Short time)		0.5: another	Rated voltage ×2.5 for 5s			
耐焊接热	1: 1F~W3A (10Ω≦R≦1MΩ)	0.5: 1F~W3A (10Ω≤R≤1MΩ)	260°C±5°C, 10s±1s			
Resistance to soldering heat	3: 1F~W3A (R<10Ω, R>1MΩ)	1: 1F~W3A (R<10Ω, R>1MΩ)				
温度突变	1: 1F	0.5: 1F	-55°C (30min.) /+125°C (30min.) 100 cycles			
Rapid change of temperature	0.5: another	0.3: another				
耐湿负荷 Moisture resistance	2: 1J, 2A, 2B 3: another	0.75: 1J, 2A, 2B 1.5: 1F 1: another	40℃±2℃, 90%~95%RH, 1000h 1.5小时ON、0.5小时OFF的周期 1.5h ON/0.5h OFF cycle			
在70℃时的耐久性	2: 1J, 2A, 2B	0.75: 1J, 2A, 2B	70℃±2℃, 1000h			
Endurance at 70℃	3: another	1: another	1.5小时ON、0.5小时OFF的周期 1.5h ON/0.5h OFF cycle			
高温放置	1	0.5: 1F	+125℃, 1000h: 1F			
High temperature exposure		0.3: another	+155℃, 1000h: 1H,1E, 1J, 2A, 2B, 2E, W2H, W3A			

■ 使用注意事项 Precautions for Use

- ●片状电阻器的基材是氧化铝,由于和安装基板的热膨胀系数不同,在反复施加热循环等热应力时,连接部的焊缝会发生裂纹。特别是大型尺寸W2H/W3A,由于热膨胀大,而且本身发热也大,使环境温度变动有较大反复和,载荷的ON/OFF有反复时,需要注意裂纹的发生。用环氧树脂印刷电路板(FR-4),在使用温度范围的上、下限进行一般性的热循环试验时,1F~2E的类型不容易发生裂纹,而W2H/W3A型则有容易发生裂纹的倾向。因热应力而发生裂纹,取决于所安装的区域的大小、焊接量、安装基板的散热性等,因此环境温度有大的变化和载荷的ON/OFF的使用条件时,请充分注意后进行设计。
- ●请注意RK73B1F,在机器组装工序中,静电的发生,施加,电阻器会有损伤的情况。

Malfunction or failure of the products in such applications may cause loss of human life or serious damage

- The substrate of chip resistors is alumina. Cracks may occur at the connection of solder (solder fillet portion) due to the difference of the coefficient of thermal expansion from a mounting board when heat stress like heat cycle, etc. are repeatedly given to them. Care should be taken to the occurrence of the cracks when the change in ambient temperature or ON/OFF of load is repeated, especially when large types of W2H/W3A which have large thermal expansion and also self heating. By general temperature cycle test using glass-epoxy (FR-4) boards under the maximum/minimum temperatures of operating temperature range, the crack does not occur easily in the types of 1F∼2E, but the crack tends to occur in the types of W2H/W3A. The occurrence of the crack by heat stress may be influenced by the size of a pad, solder volume, heat radiation of mounting board etc., so please pay careful attention to designing when a big change in ambient temperature and conditions for use like ON/OFF of load can be assumed.
- Care should be taken that RK73B1F may be damaged when static electricity occurs and is applied in the equipment assembly process.